N- and P- Channel Enhancement-Mode Dual MOSFET

BV _{DSS} /BV _{DGS}		R _{DS(ON)}	(max)	Order Number/Package		
N-Channel	P-Channel	N-Channel	P-Channel	SO-8		
200V	-200V	7.0	12	TC2320TG		

Features

- Low threshold
- Low on resistance
- ☐ Independent, electrically isolated N- and P-channels
- Low input capacitance
- Fast switching speeds
- Free from secondary breakdowns
- Low input and output leakage

Application

- Medical Ultrasound Transmitters
- ☐ High voltage pulsers
- Amplifiers
- Buffers
- Piezoelectric transducer drivers
- General purpose line drivers
- Logic level interfaces

Absolute Maximum Ratings*

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV _{DGS}
Gate-to-Source Voltage	±20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

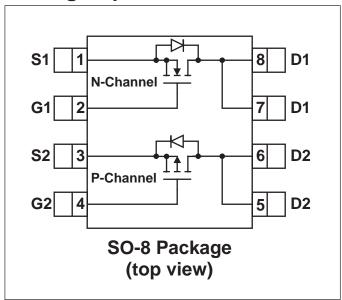
^{*}Distance of 1.6mm from case for 10 seconds.

Low Threshold DMOS Technology

The Supertex TC2320TG consist of a high voltage low threshold N-channel and P-channel MOSFET in an SO-8 package. These low threshold enhancement-mode (normally-off) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Option

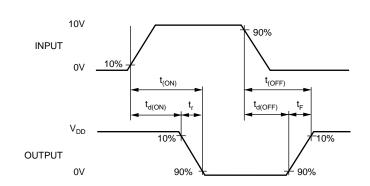


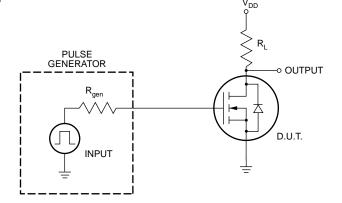
N-Channel Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Тур	Max	Unit	Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	200			V	$I_D = 100 \mu A, V_{GS} = 0 V$
V _{GS(th)}	Gate Threshold Voltage	0.6		2.0	V	$V_{GS} = V_{DS}, I_D = 1mA$
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with Temperature			-4.5	mV/°C	$I_D = 1 \text{mA}, V_{GS} = V_{DS}$
I _{GSS}	Gate Body Leakage			100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
I _{DSS}	Zero Gate Voltage Drain Current			1.0	μΑ	V _{GS} = 0V, V _{DS} = 100V
				10.0	μΑ	$V_{GS} = 0V$, $V_{DS} = Max$ Rating
				1.0	mA	$V_{GS} = 0V$, $V_{DS} = 0.8$ Max Rating $T_A = 125$ °C
I _{D(ON)}	ON-State Drain Current	0.6				$V_{GS} = 4.5V, V_{DS} = 25V$
		1.2			A	$V_{GS} = 10V, V_{DS} = 25V$
R _{DS(ON)}	Static Drain-to-Source			8.0	Ω	$V_{GS} = 4.5V, I_D = 150mA$
	ON-State Resistance			7.0	Ω	$V_{GS} = 10V, I_D = 1.0A$
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with Temperature			1.0	%/°C	$V_{GS} = 4.5V, I_D = 150mA$
G _{FS}	Forward Transconductance	150			mʊ	$V_{DS} = 25V, I_{D} = 200mA$
C _{ISS}	Input Capacitance			110		
C _{OSS}	Common Source Output Capacitance			60	pF	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$
C _{RSS}	Reverse Transfer Capacitance			23		
t _{d(ON)}	Turn-ON Delay Time			20		\/
t _r	Rise Time			15	ns	$V_{DD} = 25V$ $I_{D} = 150 \text{mA}$ $R_{GEN} = 25\Omega$
t _{d(OFF)}	Turn-OFF Delay Time			25	110	
t _f	Fall Time			25		
V _{SD}	Diode Forward Voltage Drop			1.8	V	$I_{SD} = 200 \text{mA}, V_{GS} = 0 \text{V}$
t _{rr}	Reverse Recovery Time		300		ns	$I_{SD} = 200 \text{mA}, V_{GS} = 0 \text{V}$

Notes:

Switching Waveforms and Test Circuit





 $^{1.} All\ D.C.\ parameters\ 100\%\ tested\ at\ 25^{\circ}C\ unless\ otherwise\ stated.\ (Pulse\ test:\ 300\mu s\ pulse,\ 2\%\ duty\ cycle.)$

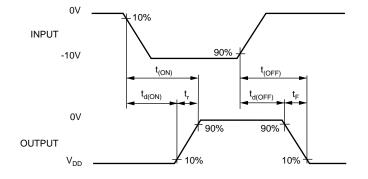
^{2.}All A.C. parameters sample tested.

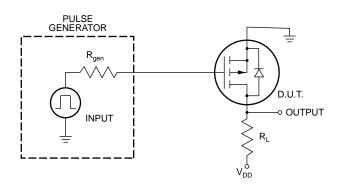
P-Channel Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Тур	Max	Unit	Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	-200			V	$V_{GS} = 0V$, $I_D = -2mA$
V _{GS(th)}	Gate Threshold Voltage	-1.0		-2.4	V	$V_{GS} = V_{DS}$, $I_D = -1 \text{mA}$
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with Temperature			4.5	mV/°C	$V_{GS} = V_{DS}$, $I_D = -1 \text{mA}$
I _{GSS}	Gate Body Leakage			-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
I _{DSS}	Zero Gate Voltage Drain Current			-10	μΑ	V _{GS} = 0V, V _{DS} = Max Rating
				-1.0	mA	$V_{GS} = 0V$, $V_{DS} = 0.8$ Max Rating $T_A = 125$ °C
I _{D(ON)}	ON-State Drain Current	-0.25	-0.7		^	$V_{GS} = -4.5V, V_{DS} = -25V$
		-0.75	-2.1		A	$V_{GS} = -10V, V_{DS} = -25V$
R _{DS(ON)}	Static Drain-to-Source		10	15	Ω	$V_{GS} = -4.5V, I_{D} = -100mA$
	ON-State Resistance		8.0	12		$V_{GS} = -10V, I_D = -200mA$
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with Temperature			1.7	%/°C	$V_{GS} = -10V, I_D = -200mA$
G _{FS}	Forward Transconductance	100	250		m&	$V_{DS} = -25V, I_{D} = -200mA$
C _{ISS}	Input Capacitance		75	125		
C _{OSS}	Common Source Output Capacitance		20	85	pF	$V_{GS} = 0V, V_{DS} = -25V$
C _{RSS}	Reverse Transfer Capacitance		10	35		f = 1 MHz
t _{d(ON)}	Turn-ON Delay Time			10	ns	
t _r	Rise Time			15	113	
t _{d(OFF)}	Turn-OFF Delay Time			20	1	
t _f	Fall Time			15		
V _{SD}	Diode Forward Voltage Drop			-1.8	V	$V_{GS} = 0V, I_{SD} = -0.5A$
t _{rr}	Reverse Recovery Time		300		ns	$V_{GS} = 0V, I_{SD} = -0.5A$

Notes:

Switching Waveforms and Test Circuit





09/17/02

 $^{1. \}text{All D.C. parameters } 100\% \text{ tested at } 25^{\circ}\text{C unless otherwise stated. (Pulse test: } 300\mu\text{s pulse, } 2\% \text{ duty cycle.)}$

^{2.}All A.C. parameters sample tested.